

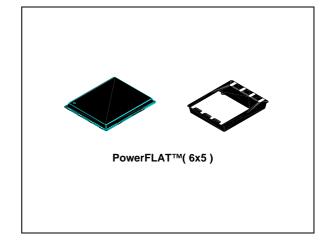
### STL80N4LL

# N-channel 40V - 0.0042Ω - 80A - PowerFLAT<sup>™</sup> (6x5) STripFET<sup>™</sup> Power MOSFET for DC-DC conversion

#### **General features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
STL80N4LL	40V	<0.005Ω	20A <sup>(1)</sup>

- When mounted on FR-4 board of 1 inch<sup>2</sup>, 2oz Cu, t<10 sec</li>
- Improved die-to-footprint ratio
- Very low profile package (1mm Max)
- Very low thermal resistance
- Conduction losses reduced
- Switching losses reduced



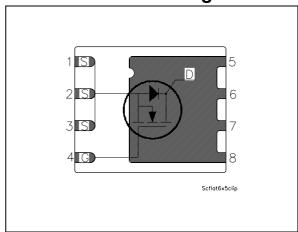
#### Description

This series of product utilizes the latest advanced design rules of ST's proprietary STripFET™
Technology. The resulting Transistor is optimized for low on-Resistance and minimal gate charge.
The chip-scaled PowerFLAT™ package allows a significant board space saving, still boosting the performance.

### **Applications**

■ Switching application

#### Internal schematic diagram



#### Order codes

Part number	Marking	Package	Packaging	
STL80N4LL	L80N4LL	PowerFLAT™ (6x5)	Tape & reel	

Contents STL80N4LL

## **Contents**

1	Electrical ratings	. 3
2	Electrical characteristics	. 4
	2.1 Electrical characteristics (curves)	. 6
3	Test circuit	. 8
4	Package mechanical data	. 9
5	Revision history	11

STL80N4LL Electrical ratings

# 1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	40	V
V <sub>GS</sub>	Gate- source voltage	±16	V
V <sub>GS</sub> <sup>(1)</sup>	Gate- source voltage	±18	V
I <sub>D</sub> <sup>(2)</sup>	Drain current (continuous) at T <sub>C</sub> = 25°C	80	Α
I <sub>D</sub> <sup>(2)</sup>	Drain current (continuous) at T <sub>C</sub> = 100°C	50	Α
I <sub>D</sub> <sup>(3)</sup>	Drain current (continuous) at T <sub>C</sub> = 25°C	20	Α
I <sub>DM</sub> <sup>(4)</sup>	Drain current (pulsed)	80	Α
P <sub>TOT</sub> (2)	Total dissipation at T <sub>C</sub> = 25°C	80	W
P <sub>TOT</sub> <sup>(3)</sup>	Total dissipation at T <sub>C</sub> = 25°C	4	W
	Derating factor (3)	0.03	W/°C
T <sub>stg</sub> T <sub>j</sub>	Storage temperature Operating junction temperature	-55 to 150	°C

- 1. Guaranteed for test time ≤ 15ms
- 2. The value is rated according Rthj-c
- 3. When mounted on FR-4 board of 1 inch $^2$ , 2oz Cu, t < 10 sec
- 4. Pulse width limited by safe operating area

Table 2. Thermal resistance

Symbol	Parameter	Value	Unit
Rthj-c	Thermal resistance junction-case Max	1.56	°C/W
Rthj-pcb (1)	Thermal operating junction-pcb Max	31.2	°C/W

1. When mounted on FR-4 board of 1 inch<sup>2</sup>, 2oz Cu, t<10 sec

Electrical characteristics STL80N4LL

## 2 Electrical characteristics

 $(T_{CASE} = 25^{\circ}C \text{ unless otherwise specified})$ 

Table 3. On/off states

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 250 \ \mu\text{A}, \ V_{GS} = 0$	40			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	$V_{DS}$ = Max rating $V_{DS}$ = Max rating@125 °C			10 100	μ <b>Α</b> μ <b>Α</b>
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 16V			±200	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1			V
R <sub>DS(on)</sub>	Static drain-source on resistance	$V_{GS} = 10V, I_D = 10 A$ $V_{GS} = 4.5V, I_D = 10 A$		0.0042 0.005	0.005 0.007	Ω Ω

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25V, f = 1 \text{ MHz}, $ $V_{GS} = 0$		2530 574 29		pF pF pF
R <sub>G</sub>	Gate input resistance	f=1 MHz Gate DC Bias = 0 Test signal level = 20mV open drain	1	3	5	Ω
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 32V$ , $I_D = 20$ A, $V_{GS} = 4.5V$ (see Figure 13)		21.5 6.9 8.2	28	nC nC nC

Table 5. Switching times

Symbol	Parameter	Test conditions	Min	Тур	Max	Unit
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>r</sub>	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD}$ = 20V, $I_D$ = 10A, $R_G$ = 4.7 $\Omega$ V <sub>GS</sub> = 10V (see Figure 12)		17 25 62 9		ns ns ns ns

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current				20	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)				80	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$I_{SD} = 20 \text{ A}, V_{GS} = 0$			1.2	V
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 20A, V_{DD} = 20V$		43		ns
$Q_{rr}$	Reverse recovery charge	di/dt = 100A/μs		64		nC
I <sub>RRM</sub>	Reverse recovery current	$T_j = 150$ °C(see Figure 17)		3		Α

<sup>1.</sup> Pulse width limited by safe operating area

<sup>2.</sup> Pulsed: Pulse duration = 300µs, duty cycle 1.5%

Electrical characteristics STL80N4LL

### 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

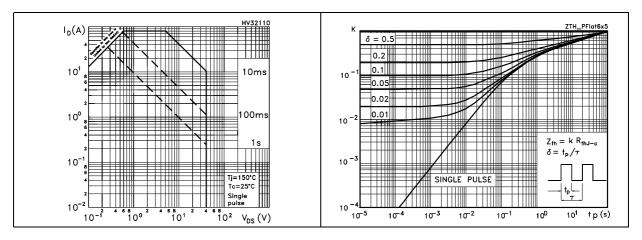


Figure 3. Output characterisics

Figure 4. Transfer characteristics

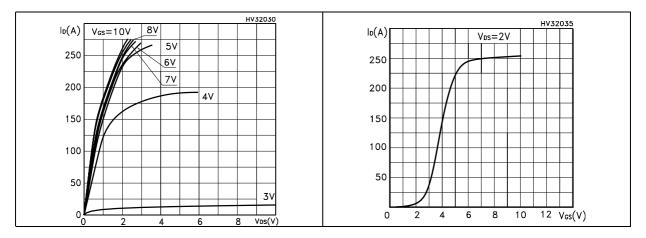
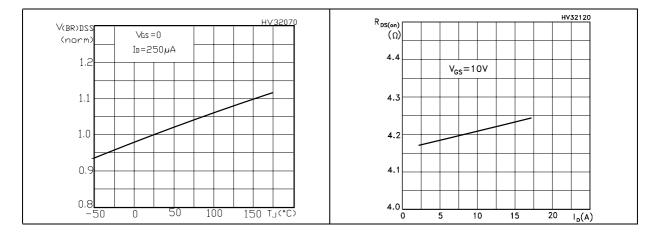


Figure 5. Normalized B<sub>VDSS</sub> vs temperature

Figure 6. Static drain-source on resistance



6/12

Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

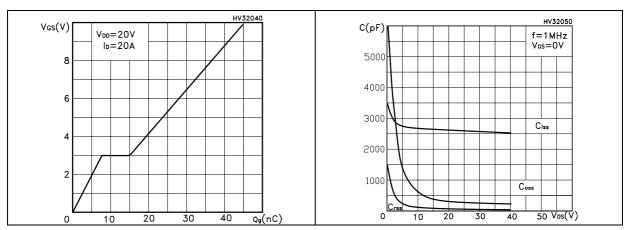


Figure 9. Normalized gate threshold voltage Figure 10. Normalized on resistance vs vs temperature temperature

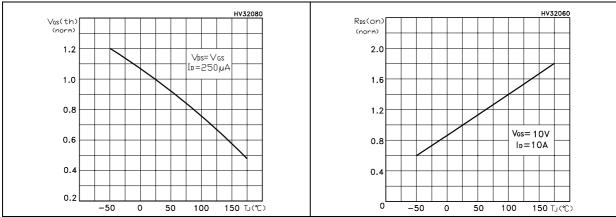
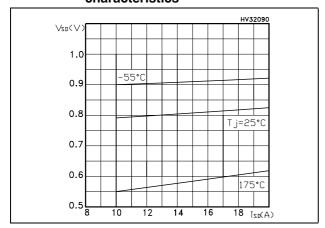


Figure 11. Source-drain diode forward characteristics



Test circuit STL80N4LL

### 3 Test circuit

Figure 12. Switching times test circuit for resistive load

Figure 13. Gate charge test circuit

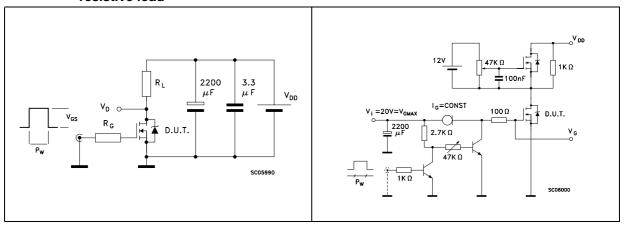


Figure 14. Test circuit for inductive load switching and diode recovery times

Figure 15. Unclamped inductive load test circuit

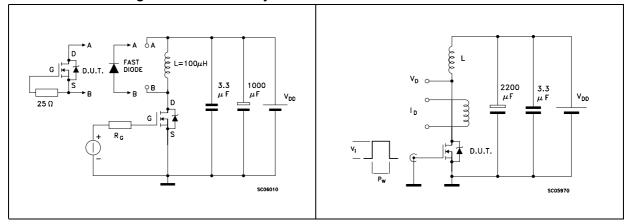
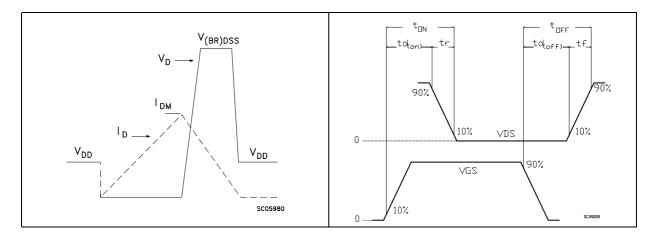


Figure 16. Unclamped inductive waveform

Figure 17. Switching time waveform



**577** 

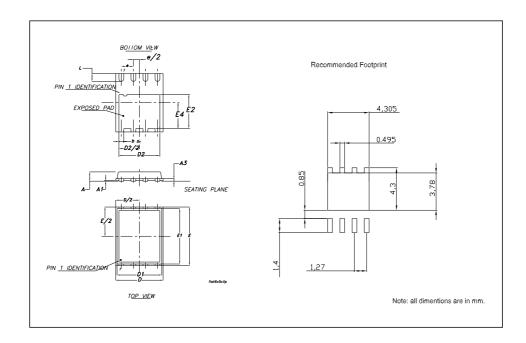
### 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: <a href="https://www.st.com">www.st.com</a>

9/12

#### PowerFLAT™ (6x5) MECHANICAL DATA

DIM	mm.					
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	0.80	0.83	0.93	0.031	0.032	0.036
A1		0.02	0.05		0.0007	0.0019
A3		0.20			0.007	
b	0.35	0.40	0.47	0.013	0.015	0.018
D		5.00			0.196	
D1		4.75			0.187	
D2	4.15	4.20	4.25	0.163	0.165	0.167
E		6.00			0.236	
E1		5.75			0.226	
E2	3.43	3.48	3.53	0.135	0.137	0.139
E4	2.58	2.63	2.68		0.103	0.105
е		1.27			0.050	
L	0.70	0.80	0.90	0.027	0.031	0.035



STL80N4LL Revision history

# 5 Revision history

Table 7. Revision history

Date	Revision	Changes	
13-May-2005	1	First release.	
20-Jun-2005	2	Updated mechanical data	
22-Jun-2005	3	New R <sub>G</sub> value on <i>Table 6</i>	
04-Jan-2006	4	New footprint	
06-Jun-2006	5	Complete version	
04-Sep-2006	6	New template, no content change	

#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2006 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

577